

MB05S THRU MB10S

Technical Data Data Sheet N0529, Rev. C

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MB05S THRU MB10S

Single-Phase 0.8A Surface Mount Glass Passivated Bridge Rectifier



Circuit Diagram



Features

- Glass passivated die construction
- Low leakage
- Ideal for printed circuit board
- Surge overload rating-30A peak
- Designed for Surface Mount Application
- Plastic Material-UL Flammability 94V-0
- Terminals finish: 100% Pure Tin
- This is a Pb Free Device
- All SMC parts are traceable to the wafer lot
- Additional testing can be offered upon request

Mechanical Data

- Case: Reliable low cost construction utilizing molded plastic technique
- Terminals: Plated Leads Solderable per MIL STD-202,Method208
- Polarity: As Marked on Case
- Mounting Position: Any

Maximum Ratings @T_A=25°C unless otherwise specified

Type Number	Symbol	MB05S	MB1S	MB2S	MB4S	MB6S	MB8S	MB10S	Units
Peak Repetitive Reverse Voltage DC Blocking Voltage	V _{RRM} Vdc	50	100	200	400	600	800	1000	V
RMS Voltage	VRMS	35	70	140	280	420	480	700	V
Average Rectified Output Current (Note1)@T _A =40℃ (Note 2)@T _A =40℃	lo				0.5 0.8				A
Non-Repetitive Peak Forward Surge Current 8.3ms Single half sine-wave superimposed on rated load (JEDEC Method)	I _{FSM}	30			A				

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Electrical Characteristics:@T _A =25°C unless otherwise specified									
Type Number	Symbol	MB05S	MB1S	MB2S	MB4S	MB6S	MB8S	MB10S	Units
Forward Voltage per element @I _F =0.8A	Vfm				1.1				V
Peak Reverse Current $@T_A = 25^{\circ}C$ At Rated DC Blocking Voltage $@T_A = 125^{\circ}C$	I _R	5 500			μA				
Typical Junction Capacitance (Note 3)	Cj				13				pF

* Pulse width < 300 $\mu s, \ duty \ cycle < 2\%$

Thermal-Mechanical Specifications:@T _A =25°C unless otherwise specified									
Type Number	Symbol MB05S MB1S MB2S MB4S MB6S MB8S MB10S						Units		
	Reja	70							°C/W
Typical Thermal Resistance per leg	Rejl	20							
Operating Junction and Storage Temperature Range	T_{J}, T_{STG}	rg -55+150 °(°C			

Note: 1. Mounted on glass epoxy PC board with 1.3mm² solder pad.

2. Mounted on aluminum substrate PC board with 1.3mm² solder pad.

3. Measured at 1.0 MHZ and applied reverse voltage of 4.0 VDC

Ratings and Characteristics Curves



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PERCENT OF RATED PEAK INVERSE VOLTGE (V)

Ordering Information

Device	Package	Plating	Shipping
MB05S THRU MB10S	MBS (Pb-Free)	Pure Sn	3000pcs / reel
MB05S THRU MB10S	MBS (Pb-Free)	Pure Sn	3000pcs / reel

For information on tape and reel specifications, including part orientation and tape sizes, please refer to our tape and reel packaging specification.



Marking Diagram		
	Where X	XXXX is YYWWL
MB05S XXXXX	MB05S YY WW L	= Type Number = Year = Week = Lot Number
E E	Cautions:	Molding resin Epoxy resin UL:94V-0

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Mechanical Dimensions MBS(Inches/Millimeters)



Carrier Tape Specification MBS



SYMBOL	Millimeters					
STWBOL	Min.	Max.				
A0	4.92	5.12				
B0	7.12	7.32				
D0	1.50	1.60				
D1	1.40	1.60				
P0	3.90	4.10				
P1	7.90	8.10				
P2	1.95	2.05				
E	1.65	1.85				
K0	2.78	2.98				
F	5.45	5.55				
W	11.90	12.10				
Т	0.24	0.30				
10P0	39.80	40.20				
抗拉拉力	≥3KG					

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